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Datasheet of SN74LV594ADBR - IC 8-BIT SHFT REG W/OUT 16-SSOP

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SN54LV594A, SN74LV594A

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SNx4LV594A 8-Bit Shift Registers With Output Registers

Features

- 2-V to 5.5-V V_{CC} Operation
- Maximum tpd of 6.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, \text{ TA} = 25^{\circ}\text{C}$
- Support Mixed-Mode Voltage Operation on All **Ports**
- 8-Bit Serial-In, Parallel-Out Shift Registers With
- Independent Direct Overriding Clears on Shift and Storage Registers
- Independent Clocks for Shift and Storage Registers
- Latch-up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

Applications

- ECG Electrocardiograms
- Storage Servers
- EPOS, ECR, and Cash Drawers
- Servers and High-Performance Computing

3 Description

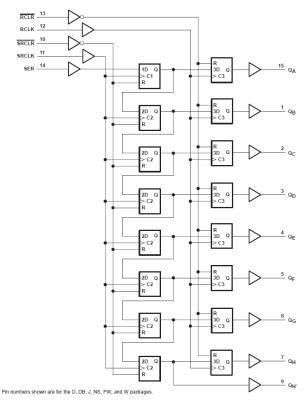
The SN74LV594A devices are 8-bit shift registers designed for 2-V to 5.5-V V_{CC} operation.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
	SSOP (16)	6.20 mm × 5.30 mm
SN74LV594A	SOIC (16)	9.90 mm × 3.91 mm
	TSSOP (16)	5.00 mm × 4.40 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Logic Diagram (Positive Logic)





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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision I (April 2005) to Revision J

Page

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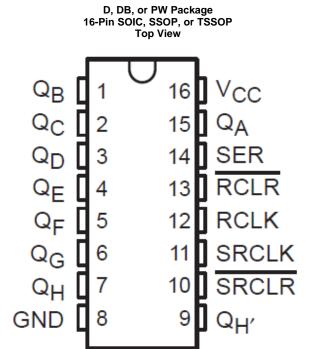


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5 Pin Configuration and Functions



Pin Functions

	PIN	I/O	DESCRIPTION
NO.	NAME	1/0	DESCRIPTION
1	Q_{B}	0	Output B
2	$Q_{\mathbb{C}}$	0	Output C
3	Q_D	0	Output D
4	Q _E	0	Output E
5	Q _F	0	Output F
6	Q _G	0	Output G
7	Q _H	0	Output H
8	GND	-	Ground pin
9	Q _H '	0	Q _H inverted
10	SRCLR	I	Serial clear
11	SRCLK	1	Serial clock
12	RCLK	I	Storage clock
13	RCLR	I	Storage clear
14	SER	I	Serial input
15	Q _A	0	Output A
16	Vcc	ı	Power pin



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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

			MIN	MAX	UNIT
V _{CC}	Supply voltage		-0.5	7	V
V_{I}	Input voltage (2)		-0.5	7	V
Vo	Voltage range applied to any output in the h	nigh-impedance or power-off state (2)	-0.5	7	V
Vo	Output voltage (2)(3)		-0.5	$V_{CC} + 0.5$	V
I _{IK}	Input clamp current	V _I < 0	-20		mA
I _{OK}	Output clamp current	V _O < 0	-50		mA
Io	Continuous output current	$V_O = 0$ to V_{CC}	-25	25	mA
T _{stg}	Storage temperature		-65	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	2000	
V _(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	1000	V

¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

³⁾ The value is limited to 5.5 V maximum.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

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6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			SN54LV5	94A ⁽²⁾	SN74L\	/594A	
			MIN	MAX	MIN	MAX	UNIT
V _{CC}	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
	I Bala Jawa Baas da salta aa	V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.7		$V_{CC} \times 0.7$		V
V_{IH}	High-level input voltage	V _{CC} = 3 V to 3.6 V	V _{CC} × 0.7		$V_{CC} \times 0.7$		V
		V _{CC} = 4.5 V to 5.5 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5		0.5	
	Laurel in a tradition	V _{CC} = 2.3 V to 2.7 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	V
V_{IL}	Low-level input voltage	V _{CC} = 3 V to 3.6 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	V
		V _{CC} = 4.5 V to 5.5 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
VI	Input voltage		0	5.5	0	5.5	V
Vo	Output voltage		0	V_{CC}	0	V _{CC}	V
		V _{CC} = 2 V		-50		-50	μΑ
	TP-L-LPC	V _{CC} = 2.3 V to 2.7 V		-2		-2	
I _{OH}	High-level input current	V _{CC} = 3 V to 3.6 V		6		6	mA
		V _{CC} = 4.5 V to 5.5 V		-12		-12	
		V _{CC} = 2 V		50		50	μΑ
	The desired and a second	V _{CC} = 2.3 V to 2.7 V		2		2	
I _{OL}	Low-level output current	V _{CC} = 3 V to 3.6 V		6		6	mA
		V _{CC} = 4.5 V to 5.5 V		12		12	
				200		200	
Δt/Δν	Input transition rise or fall r $V_{CC} = 4.5 \text{ V}$ to 5.5 V	ate $V_{CC} = 2.3 \text{ V}$ to 2.7 V $V_{CC} = 3 \text{ V}$ to 3.6 V		100		100	ns/V
	VCC = 4.3 V tO 3.3 V			20	-12 -12 50 50 2 2 6 6 12 12 200 200 100 100		
T _A	Operating free-air temperat	ture	– 55	125	-40	125	°C

All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report Implications of Slow or Floating CMOS Inputs, SCBA004.

6.4 Thermal Information

			SN74LV594A		
	THERMAL METRIC ⁽¹⁾	D (SOIC)	DB (SSOP)	PW (TSSOP)	UNIT
		16 PINS	16 PINS	16 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	80.2	97.8	106.1	
R _{0JC(top)}	Junction-to-case (top) thermal resistance	40.3	48.1	40.8	
$R_{\theta JB}$	Junction-to-board thermal resistance	38	48.5	51.1	°C/W
ΨЈТ	Junction-to-top characterization parameter	9	10	3.8	
ΨЈВ	Junction-to-board characterization parameter	37.7	47.9	50.6	

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

⁽²⁾ Product Preview



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6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST	vcc	SN54	LV594A			ILV594A TO 85°C			LV594A TO 125°C		UNIT
	CONDITIONS		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
	$I_{OH} = -50 \ \mu A$	2 V to 5.5 V	V _{CC} - 0.1			V _{CC} - 0.1			V _{CC} - 0.1			
.,	I _{OH} = -2 μA	2.3 V	2			2			2			V
V _{OH}	$I_{OH} = -6 \mu A$	3 V	2.48			2.48			2.48			V
	$I_{OH} = -12 \mu A$	4.5 V	3.8			3.8			3.8			
	$I_{OH} = -50 \mu A$	2 V to 5.5 V			0.1			0.1			0.1	
	$I_{OH} = -2 \mu A$	2.3 V			0.4			0.4			0.4	V
V _{OL}	$I_{OH} = -6 \mu A$	3 V			0.44			0.44			0.44	V
	$I_{OH} = -12 \mu A$	4.5 V			0.55			0.55			0.55	
I _I	V _I = 5.5 V or GND	0 to 5.5 V			±1			±1			±1	μA
Icc	$V_I = V_{CC}$ of GND, $I_O = 0$	5.5 V			20			20			20	μA
I _{off}	V _I or V _O = 0 to 5.5 V	0			5			5			5	μA
C _i	V _I = V _{CC} or GND	3.3 V		3.5			3.5					pF

6.6 Switching Characteristics: $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted). See Figure 1.

PARAMETER	FROM	TO	LOAD	-	T _A = 25°C		SN54I	v594A	SN74LV -40°C TO		SN74LV		UNIT	
	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
			C _L = 15 pF	65 ⁽¹⁾	80 ⁽¹⁾		45 ⁽¹⁾		45		35		MHz	
f _{max}			C _L = 50 pF	60	70		40		40		30		IVITIZ	
t _{PLH}		0 0			6.4 ⁽¹⁾	10.6 ⁽¹⁾	1 ⁽¹⁾	11.1 ⁽¹	1	11.1	1	12.5		
t _{PHL}	SRCLK	$Q_A - Q_H$			6.3 ⁽¹⁾	10.4 ⁽¹⁾		11.1 ⁽¹	1	11.1	1	12.5		
t _{PLH}		Ou:	0 45 75		7.4 ⁽¹⁾	12.1 ⁽¹⁾	1 (1)	12.8 ⁽¹	1	12.8	1	15		
t _{PHL}		Q _H '	$C_L = 15 pF$		7.2 ⁽¹⁾	11.6 ⁽¹⁾	1 ⁽¹⁾	12.8 ⁽¹	1	12.8	1	15	ns	
	RCLK Q _A	$Q_A - Q_H$			7.9 ⁽¹⁾	12.7 ⁽¹⁾	1 ⁽¹⁾	13.6 ⁽¹	1	13.6	1	15.5		
t _{PHL}		Q _H			7.4 ⁽¹⁾	11.9 ⁽¹⁾	1 ⁽¹⁾	13.1 ⁽¹	1	13.1	1	15.5		
t _{PLH}		0 0			9.5	14.1	1	14.6	1	14.6	1	17		
t _{PHL}	SRCLR	$Q_A - Q_H$			10.8	15.5	1	17.2	1	17.2	1	19.5		
t _{PLH}			C = 50 pE		10.6	15.7	1	16.5	1	16.5	1	18.5	ns	
t _{PHL}	Q _H ,	Q _H ,	$Q_{H'}$ $C_L = 50$	O _L = 50 pr		11.3	16.1	1	18.6	1	18.6	1	20.5	115
	RCLR Q _A – Q _H			12.1	17.4	1	19	1	19	1	21			
t _{PHL}		Q _H '			11.6	16.5	1	18.6	1	18.6	1	20.6		

⁽¹⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested.

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6.7 Switching Characteristics: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted). See Figure 1.

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T	T _A = 25°C		SN54LV594A		SN74LV594A -40°C TO 85°C		SN74LV594A -40°C TO 125°C		UNIT
	(INFUI)	(OUIFUI)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
4			C _L = 15 pF	80 ⁽¹⁾	120 ⁽¹⁾		70 ⁽¹⁾		70		60		NAL I-
f_{max}			C _L = 50 pF	55	105		50		50		40		MHz
t _{PLH}		0 0			4.6 ⁽¹⁾	8 ⁽¹⁾	1 ⁽¹⁾	8.5 ⁽¹⁾	1	8.5	1	10.5	
t _{PHL}	SRCLK	$Q_A - Q_H$			4.9 ⁽¹⁾	8.2 ⁽¹⁾	1 ⁽¹⁾	8.8(1)	1	8.8	1	10.5	
t _{PLH}		Q _H ,	0 45 75		5.4 ⁽¹⁾	9.1 ⁽¹⁾	1 ⁽¹⁾	9.7 ⁽¹⁾	1	9.7	1	11.5	
t _{PHL}		$Q_{H'}$	C _L = 15 pF		5.5 ⁽¹⁾	9.2 ⁽¹⁾	1 ⁽¹⁾	9.9 ⁽¹⁾	1	9.9	1	11.6	ns
	RCLK	$Q_A - Q_H$			6 ⁽¹⁾	9.8 ⁽¹⁾	1 ⁽¹⁾	10.6 ⁽¹⁾	1	10.6	1	12.1	
t _{PHL}		Q _H ,			5.6 ⁽¹⁾	9.2 ⁽¹⁾	1 ⁽¹⁾	10 ⁽¹⁾	1	10	1	12	
t _{PLH}		0 0					1	11.1	1	11.1	1	12.5	
t _{PHL}	SRCLR	$Q_A - Q_H$					1	13.1	1	13.1	1	15	
t _{PLH}		0	C 50 7 5				1	12.4	1	12.4	1	14	
t _{PHL}		Q _H	$C_L = 50 \text{ pF}$				1	13.9	1	13.9	1	15.5	ns
	RCLR	$Q_A - Q_H$					1	14.4	1	14.4	1	16.1	
t _{PHL}		Q _H ,					1	14	1	14	1	16	

⁽¹⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested.

6.8 Switching Characteristics: $V_{CC} = 5 V \pm 0.5 V$

over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted). See Figure 1.

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	Т,	_{\(\)} = 25°C		SN54L	V594A	SN74LV		SN74LV5 -40°C TO 1	-	UNIT
	(INFOT) (OUTFOT) CAPACIT		CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX			
			C _L = 15 pF	135 ⁽¹⁾	170 ⁽¹⁾		115 ⁽¹⁾		115		105		MHz
f _{max}			C _L = 50 pF	120	140		95		95		85		IVITIZ
t _{PLH}		0 0			3.3 ⁽¹⁾	6.2 ⁽¹⁾	1 ⁽¹⁾	6.5 ⁽¹⁾	1	6.5	1	8	
t _{PHL}	SRCLK	$Q_A - Q_H$			3.7 ⁽¹⁾	6.5 ⁽¹⁾	1 ⁽¹⁾	6.9 ⁽¹⁾	1	6.9	1	8.5	
t _{PLH}		0	0 45 75		3.7 ⁽¹⁾	6.8(1)	1 ⁽¹⁾	7.2 ⁽¹⁾	1	7.2	1	8.5	
t _{PHL}		$Q_{H'}$	$C_L = 15 pF$		4.1 ⁽¹⁾	7.2 ⁽¹⁾	1 ⁽¹⁾	7.6 ⁽¹⁾	1	7.6	1	9	ns
	RCLK	$Q_A - Q_H$			4.5 ⁽¹⁾	7.6(1)	1 ⁽¹⁾	8.2 ⁽¹⁾	1	8.2	1	9.5	
t _{PHL}		Q _H ,			4.1 ⁽¹⁾	7.1 (1)	1 ⁽¹⁾	7.6 ⁽¹⁾	1	7.6	1	9	
t _{PLH}		0 0			4.9	7.8	1	8.3	1	8.3	1	9.6	
t _{PHL}	SRCLR	$Q_A - Q_H$			5.8	8.9	1	9.7	1	9.7	1	11	
t _{PLH}		0	0 50 - 5		5.5	8.6	1	9.1	1	9.1	1	10.5	
t _{PHL}		Q _H	$C_L = 50 pF$		6	9.2	1	10.1	1	10.1	1	11.5	ns
	RCLR	$Q_A - Q_H$			6.6	10	1	10.7	1	10.7	1	12	
t _{PHL}		Q _H			6	9.2	1	10.1	1	10.1	1	11.5	

⁽¹⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested.



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6.9 Timing Requirements: $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V. See Figure 1.

			T _A = 2	5°C	SN54LV	594A	SN74LV -40°C TO		SN74LV59 -40°C TO 1		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Dulas duration	RCLK or SRCLK high or low	7		7.5		7.5		8.5		
t _w	Pulse duration	RCKR or SCRCLR low	6		6.5		6.5		7.5		ns
		SER before SRCLK↑	5.5		5.5		5.5		6		
		SRCLK↑ before RCLK↑	8		9		9		10		
t _{su}	Setup time	SCRCLR low before RCLK↑(1)	8.5		9.5		9.5		10.5		ns
*su	Cotap umo	SRCLR high (inactive) before SRCLK↑	6		6.8		6.8		7.5		
		RCLK high (inactive) before RCLK↑	6.7		7.6		7.6		8.5		
t _h	Hold time	SER after SRCLK↑	1.5		1.5		1.5		2		ns

⁽¹⁾ This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

6.10 Timing Requirements: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V. See Figure 1.

			T _A = 2	5°C	SN54LV	594A	SN74LV59 -40°C TO	-	SN74LV59 -40°C TO 1		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Pulse duration	RCLK or SRCLK high or low	5.5		5.5		5.5		6.5		
t _w	Pulse duration	RCKR or SCRCLR low	5		5		5		6		ns
		SER before SRCLK↑	3.5		3.5		3.5		4		
		SRCLK↑ before RCLK↑	8		8.5		8.5		9.5		
t _{su}	Setup time	SCRCLR low before RCLK↑ ⁽¹⁾	8		9		9		10		ns
*Su	Cotap umo	SRCLR high (inactive) before SRCLK↑	4.2		4.8		4.8		5.5		
		RCLK high (inactive) before RCLK↑	4.6		5.3		5.3		6		
t _h	Hold time	SER after SRCLK↑	1.5		1.5		1.5		2		ns

⁽¹⁾ This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

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6.11 Timing Requirements: $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$

over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V. See Figure 1.

			T _A = 2	5°C	SN54LV	594A	SN74LV		SN74LV5 -40°C TO 1		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
. 51		RCLK or SRCLK high or low	5		5		5		6		
t _w	Pulse duration	RCKR or SCRCLR low	5.2		5.2		5.2		6.2		ns
		SER before SRCLK↑	3		3		3		3.5		
		SRCLK↑ before RCLK↑	5		5		5		6		
t _{su}	Setup time	SCRCLR low before RCLK↑ ⁽¹⁾	5		5		5		5.5		ns
su	Cotap time	SRCLR high (inactive) before SRCLK↑	2.9		3.3		3.3		4		110
		RCLK high (inactive) before RCLK↑	3.2		3.7		3.7		4.5		
t _h	Hold time	SER after SRCLK↑	2		2		2		2.5		ns

⁽¹⁾ This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

6.12 Noise Characteristics (1)

over operating free-air temperature range (unless otherwise noted), V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C

	PARAMETER	MIN	TYP	MAX	UNIT
$V_{OL(P)}$	Quiet output, maximum dynamic V _{OL}		0.5	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.1	-0.8	V
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}		2.8		V
$V_{IH(V)}$	High-level dynamic input voltage	2.31			V
V _{IL(V)}	Low-level dynamic input voltage			0.99	V

⁽¹⁾ Characteristics are for surface-mount packages only.

6.13 Operating Characteristics

 $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC}	TYP	UNIT
	Daway discipation conscitance	f 40 MH=	3.3 V	93	"F
Cpo	Power dissipation capacitance	f = 10 MHz	5 V	112	pF



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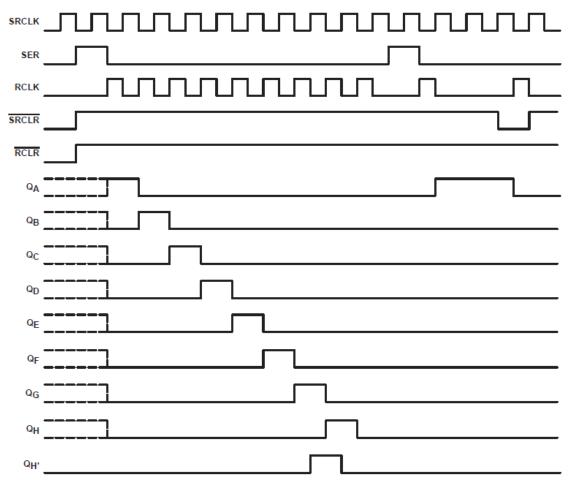
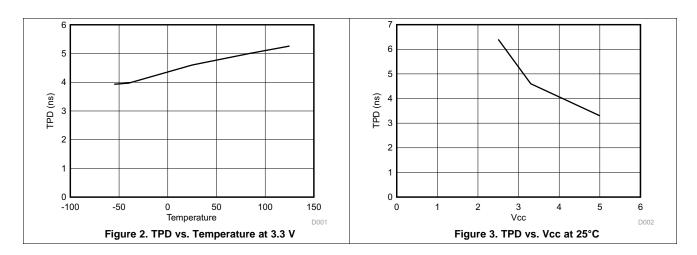


Figure 1. Timing Diagram

6.14 Typical Characteristics



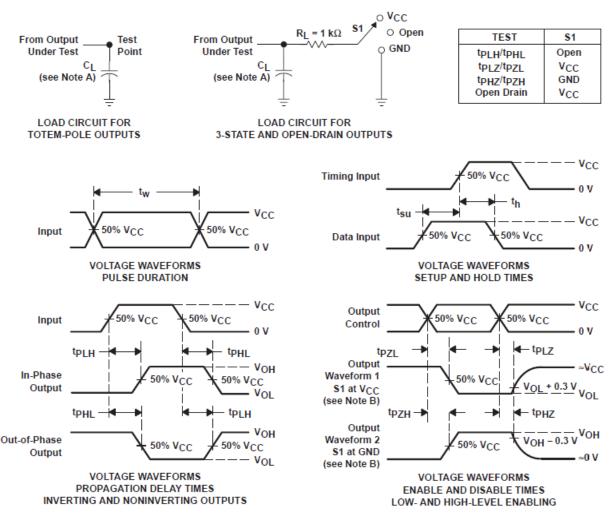


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7 Parameter Measurement Information



- NOTES: A. C_I includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \le 1$ MHz, $Z_O = 50 \Omega$, $t_f \le 3$ ns. $t_f \le 3$ ns.
 - D. The outputs are measured one at a time, with one input transition per measurement.
 - E. tpLZ and tpHZ are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpHL and tpLH are the same as tpd.
 - H. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms



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8 Detailed Description

8.1 Overview

The SN74LV594A devices are 8-bit shift registers designed for 2-V to 5.5-V V_{CC} operation.

These devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. Separate clocks (RCLK, SRCLK) and direct overriding clear (RCLR, SRCLR) inputs are provided on the shift and storage registers. A serial output $(Q_{H'})$ is provided for cascading purposes. The shift-register (SRCLK) and storage-register (RCLK) clocks are positive-edge triggered. If the clocks are tied together, the shift register always is one clock pulse ahead of the storage register.

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8.2 Functional Block Diagram

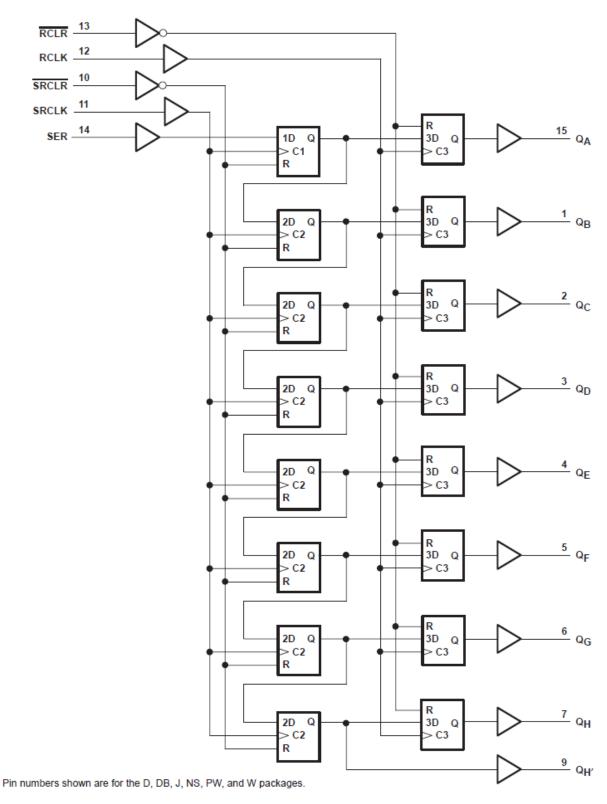


Figure 5. Logic Diagram (Positive Logic)

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8.3 Feature Description

The device's wide operating range allows it to be used in a variety of systems that use different logic levels. The low propagation delay allows fast switching and higher speeds of operation. In addition, the low ground bounce stabilizes the performance of non-switching outputs while another output is switching.

8.4 Device Functional Modes

Table 1. Function Table

		INPUTS			FUNCTION
SER	SRCLK	SRCLR	RCLK	RCLR	FUNCTION
Х	X	L	X	X	Shift register is cleared.
L	1	Н	X	Х	First stage of shift register goes low. Other stages store the data of previous stage, repectively.
Н	1	Н	X	Х	First stage of shift register goes high. Other stages store the data of previous stage, respectively.
L	↓	Н	Х	Х	Shift register state is not changed.
Х	X	X	X	L	Storage register is cleared.
Х	X	X	↑	Н	Shift register data is stored in the storage register.
Х	X	X		Н	Storage register state is not changed.

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9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The SN74LV594A is a low drive CMOS device that can be used for a multitude of bus interface type applications where output ringing is a concern. The low drive and slow edge rates will minimize overshoot and undershoot on the outputs.

9.2 Typical Application

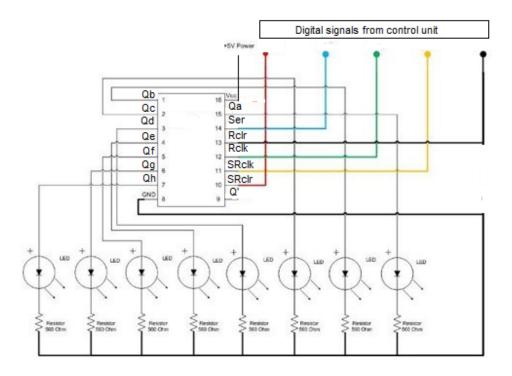


Figure 6. Typical Application Schematic

9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads so consider routing and load conditions to prevent ringing.



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Typical Application (continued)

9.2.2 Detailed Design Procedure

- · Recommended input conditions:
 - Rise time and fall time specs. See (Δt/ΔV) in Recommended Operating Conditions.
 - Specified high and low levels. See (V_{IH} and V_{IL}) in *Recommended Operating Conditions*.
 - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid V_{CC}.
- Recommended output conditions:
 - Load currents should not exceed 25 mA per output and 50 mA total for the part.
 - Outputs should not be pulled above V_{CC}.

9.2.3 Application Curves

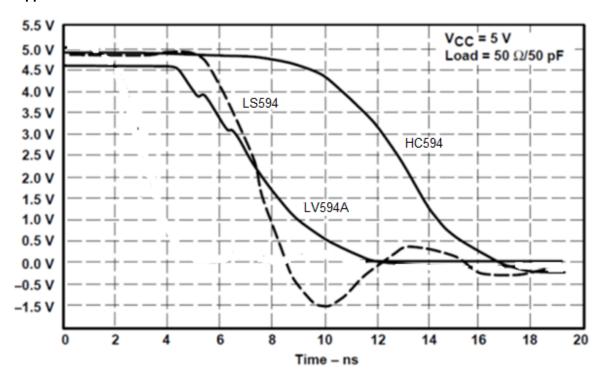


Figure 7. Switching Characteristics Comparison

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10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the Recommended Operating Conditions. Each V_{CC} terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, TI recommends a 0.1- μ F capacitor and if there are multiple V_{CC} terminals then TI recommends a 0.01- μ F or 0.022- μ F capacitor for each power terminal. Multiple bypass capacitors can be paralleled to reject different frequencies of noise. Frequencies of 0.1 μ F and 1 μ F are commonly used in parallel. The bypass capacitor should be installed as close as possible to the power terminal for best results.

11 Layout

11.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only three of the four buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or V_{CC} whichever make more sense or is more convenient. Floating outputs is generally acceptable, unless the part is a transceiver. If the transceiver has an output enable pin it will disable the outputs section of the part when asserted. This will not disable the input section of the I.O's so they also cannot float when disabled.

11.2 Layout Example

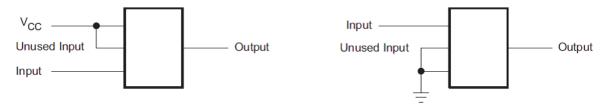


Figure 8. Layout Example



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12 Device and Documentation Support

12.1 Trademarks

All trademarks are the property of their respective owners.

12.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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PACKAGE OPTION ADDENDUM

5-Mar-2015

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN74LV594AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594ADBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594ADRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU CU SN	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWT	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples
SN74LV594APWTG4	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV594A	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



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PACKAGE OPTION ADDENDUM

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(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): Ti defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "--" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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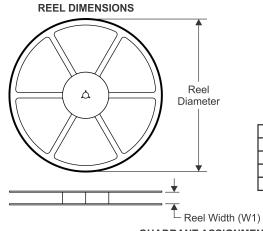
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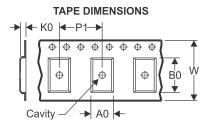


PACKAGE MATERIALS INFORMATION

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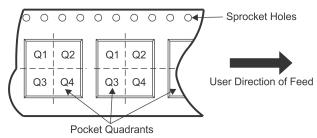
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

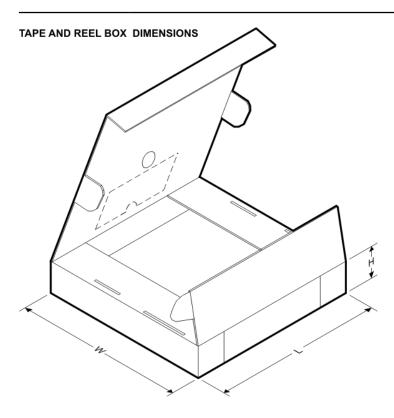
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV594ADBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
SN74LV594ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LV594APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV594APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV594APWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV594APWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

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*All dimensions are nominal

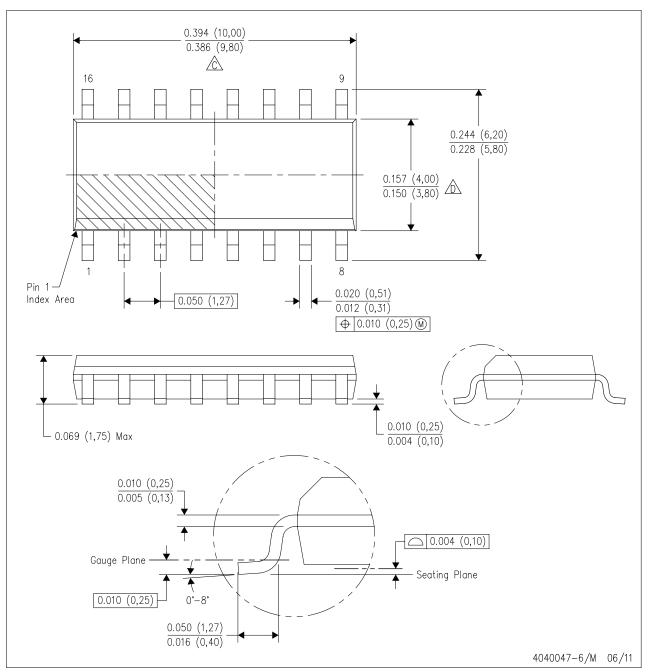
7 til dilliciololio are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV594ADBR	SSOP	DB	16	2000	367.0	367.0	38.0
SN74LV594ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LV594APWR	TSSOP	PW	16	2000	364.0	364.0	27.0
SN74LV594APWR	TSSOP	PW	16	2000	367.0	367.0	35.0
SN74LV594APWRG4	TSSOP	PW	16	2000	367.0	367.0	35.0
SN74LV594APWT	TSSOP	PW	16	250	367.0	367.0	35.0



MECHANICAL DATA

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.

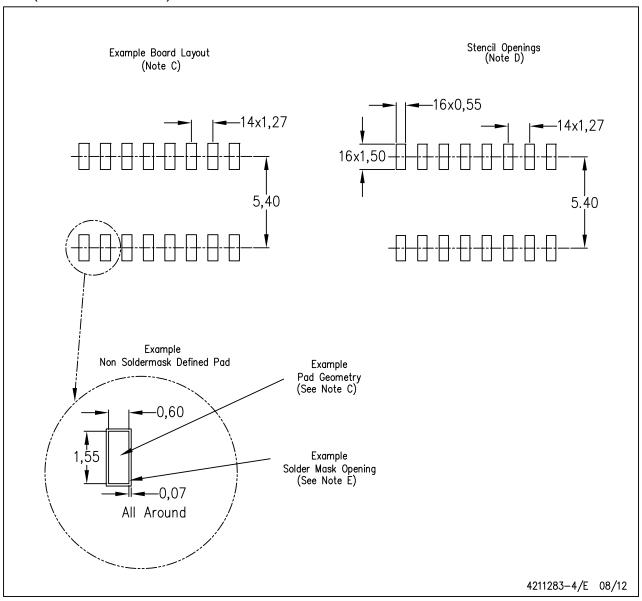




LAND PATTERN DATA

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

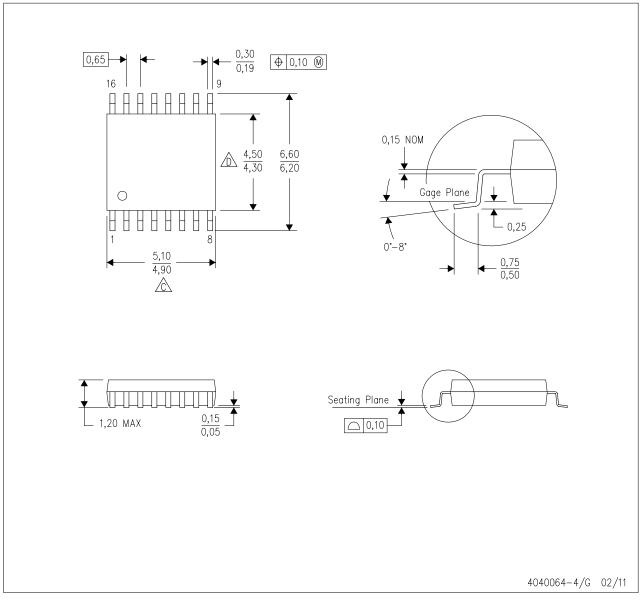




MECHANICAL DATA

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153

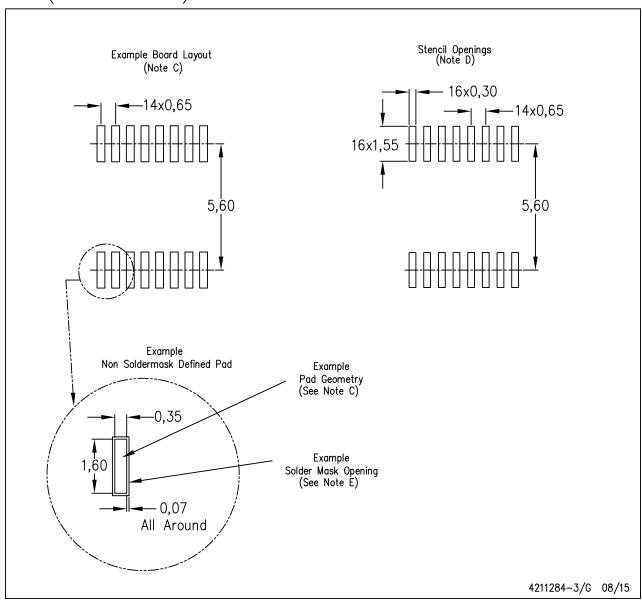




LAND PATTERN DATA

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





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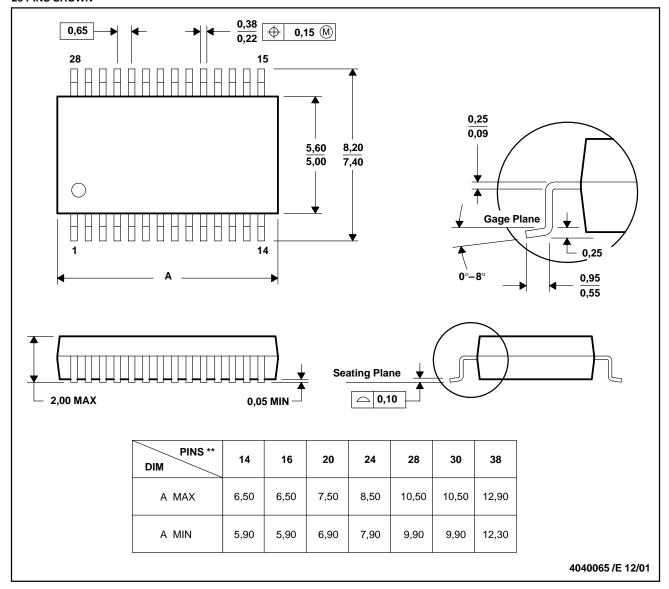
MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

28 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150





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Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

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Application
Application

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